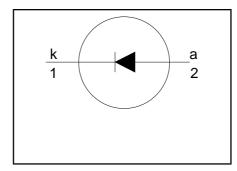
Damper diode fast, high-voltage

BY459X-1500, BY459X-1500S

FEATURES

- Low forward volt drop
- Fast switching
- Soft recovery characteristic
 High thermal cycling performance
 Isolated mounting tab

SYMBOL



QUICK REFERENCE DATA

$$V_R = 1500 \text{ V}$$
 $V_F \le 1.2 \text{ V} / 1.25 \text{ V}$
 $I_{F(peak)} = 12 \text{ A (f = 48 kHz)}$
 $I_{F(peak)} = 10 \text{ A (f = 82 kHz)}$
 $I_{FSM} \le 100 \text{ A}$
 $t_{rr} \le 350 \text{ ns } / 220 \text{ ns}$

GENERAL DESCRIPTION

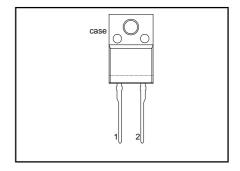
Glass-passivated double diffused rectifier diode featuring fast forward recovery and low forward recovery voltage. The device is intended for use in HDTV receivers and multi-sync monitor horizontal deflection circuits.

The BY459X series is supplied in the conventional leaded SOD113 package.

PINNING

PIN	DESCRIPTION	
1	cathode	
2	anode	
tab	isolated	

SOD113



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MA	UNIT	
V_{RSM}	Peak non repetitive reverse voltage		-	1500		V
V_{RRM}	Peak repetitive reverse voltage		-	1500		V
V_{RWM}	Crest working reverse voltage		-	13	00	V
	Dools would be forward or mont	f 40 kH=:		-1500	-1500S	_
F(peak)	Peak working forward current	f = 48 kHz; f = 82 kHz;	-	12 -	- 10	A A
I _{FRM}	Peak repetitive forward current	t = 100 μs	-	100		Α
I _{F(RMS)}	RMS forward current		-	30		Α
I _{FSM}	Peak non-repetitive forward	t = 10 ms	-	10	-	Α
	current	t = 8.3 ms sinusoidal; $T_i = 150 ^{\circ}\text{C}$ prior to surge; with reapplied $V_{\text{RWM(max)}}$	-	110		А
T_{stg}	Storage temperature Operating junction temperature	odigo, mari odppilod v _{RWM(max)}	-40 -	150 150		ပံ့ပံ

Philips Semiconductors Product specification

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ISOLATION LIMITING VALUE & CHARACTERISTIC

 T_{hs} = 25 $^{\circ}$ C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	R.M.S. isolation voltage from both terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	-		2500	V
C _{isol}	Capacitance from both terminals to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th j-hs}$ $R_{th j-a}$	heatsink	with heatsink compound without heatsink compound in free air.		- - 55	4.8 5.9 -	K/W K/W K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	TYP.		MAX.		UNIT
		BY459X-	1500	1500S	1500	1500S	
V _F	Forward voltage	I _F = 6.5 A I _F = 6.5 A; T _i = 125 °C	0.95 0.85	1.05 0.95	1.30 1.20	1.35 1.25	V
I _R	Reverse current	$\dot{V}_{R} = 1300 \text{ V}$ $V_{R} = 1300 \text{ V}$; $T_{j} = 125 \text{ °C}$	-	-	250 1	250 1	μA mA

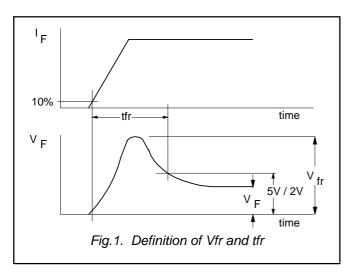
DYNAMIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	TYP.		M	UNIT	
		BY459X-	1500	1500S	1500	1500S	
$\begin{matrix} t_{rr} \\ Q_s \\ V_{fr} \\ t_{fr} \end{matrix}$		$\begin{array}{l} I_F = 1 \; A, \; V_R \geq 30 \; V; \\ I_F = 2 \; A, \; \text{-d}I_F/dt = 20 \; A/\mu s \\ I_F = 6.5A, \; \text{d}I_F/dt = 50A/\mu s \\ I_F = 6.5A, \; \text{d}I_F/dt = 50A/\mu s \end{array}$	0.25 2.0 8.0 170	0.17 0.70 11.0 200	0.35 3.0 14.0 250	0.22 0.95 19.0 300	μs μC V ns

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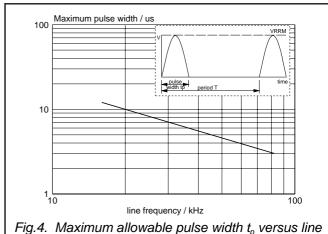
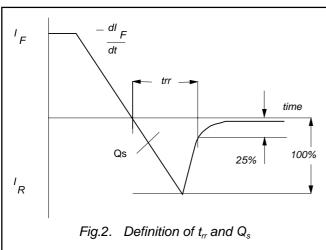
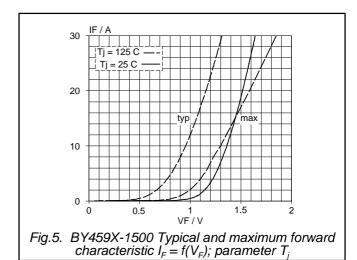


Fig.4. Maximum allowable pulse width $t_{\rm p}$ versus line frequency; Basic horizontal deflection circuit.





VCC Line output transformer LY JUJUJ Cf Cs D1 deflection transistor Fig.3. Basic horizontal deflection circuit.

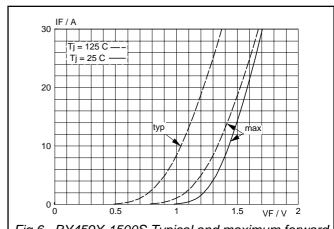
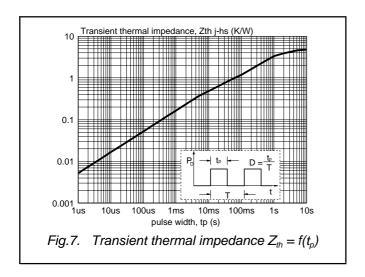


Fig.6. BY459X-1500S Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

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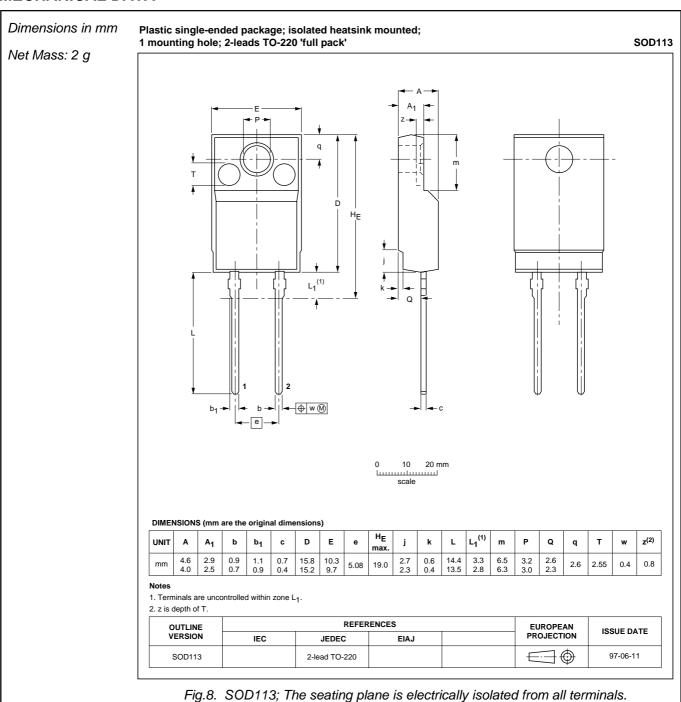
BY459X-1500, BY459X-1500S



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BY459X-1500, BY459X-1500S

MECHANICAL DATA



Notes

- Refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

DATA SHEET STATU	DATA SHEET STATUS						
DATA SHEET STATUS ¹	PRODUCT STATUS ²	DEFINITIONS					
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice					
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product					
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A					

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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November 2002 6 Rev 2.000

¹ Please consult the most recently issued datasheet before initiating or completing a design.

² The product status of the device(s) described in this datasheet may have changed since this datasheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.